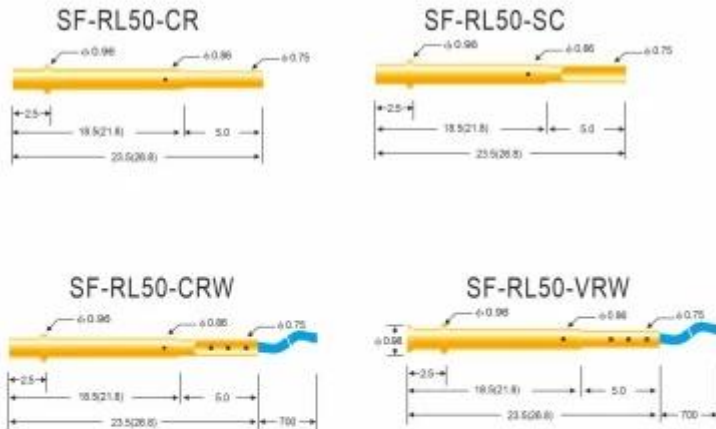




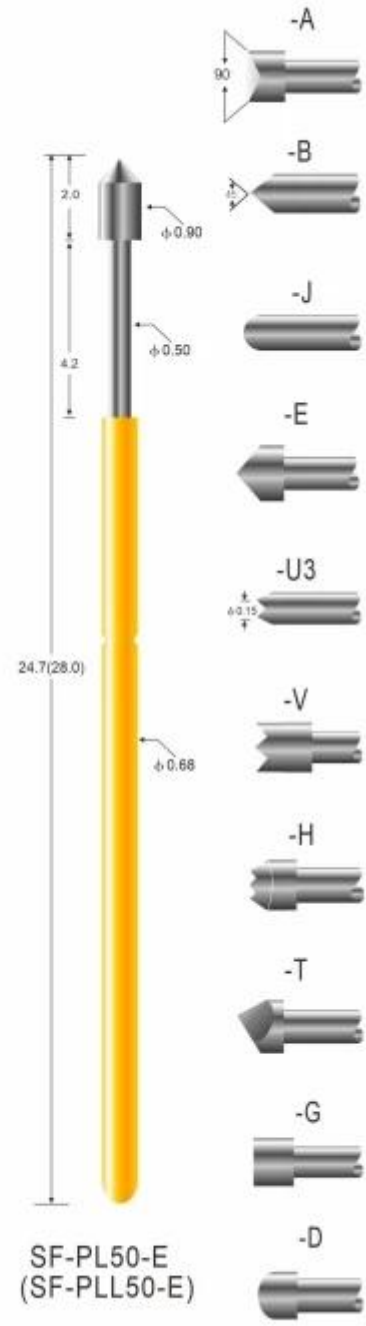
SFENG 1984 () CB)



技术规格 PROBE SPECIFICATIONS

| | |
|------------------------------------|--|
| Recommended minimum center 最小间距 | 1.27mm(.0500 ") |
| Mounting hole size 钻孔尺寸 | V: 0.90mm(.0354 ") W: 0.95mm(.0374 ") |
| Full travel 行程 | 4.20(.1654 ") |
| Spring force 弹簧压力 | 120g(克) |
| Materials and finishes 材料及涂饰 | Plunger:SK4, Ni or Au plated BeCu, Ni or Au plated Barrel:Phosphor bronze, Au plated Spring:Stainless steel |
| Current ration 额定电流 | 3A(安培) |
| Contact resistance 接触电阻 | 50mΩ(毫欧姆) |

Receptacle specifications
Materials and finishes: Phosphor bronze,Gold plated



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- Pogo pin
- BGA
- QZVZLM
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1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



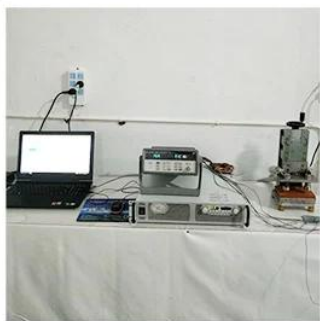
4. Quality inspection



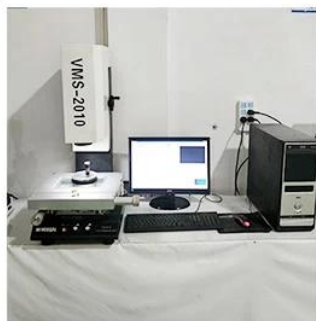
5. Finished products



6. Packing



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope



Q1. 請說明

A1: 請說明

Q2. 請說明

A2: 請說明QC

Q3. 請說明

A3: 請說明

Q4. 請說明

A4: 請說明

Q5. 請說明

A5 請說明m

Q6. 請說明

A6: 請說明

Q7. 請說明 OEM 與 ODM 的

A7: 請說明 OEM /ODM 的 P 請說明

Q8. 請說明

A8: 請說明

請

請說明 DHL UPS FedEx TNT EMS

請說明 Exwork FOB CNF CIF



2023 ISO Certificate



Patent for Coaxial Structure



Patent for Honeycomb current probe











CIBF2021

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Suzhou Shengyifurui Electronic Technology Co., Ltd

No.3B013

